S/N: New Patent Appl.

Atty. Docket No. SA9-99-140US2



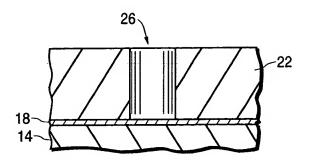


FIG.1 (PRIOR ART)

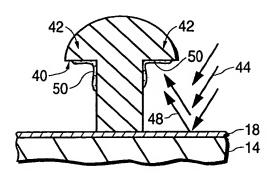


FIG.4 (PRIOR ART)

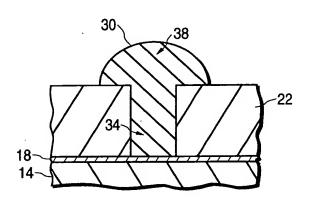


FIG.2 (PRIOR ART)

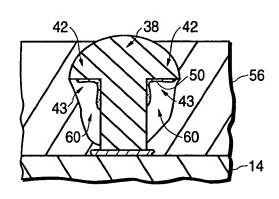


FIG.5 (PRIOR ART)

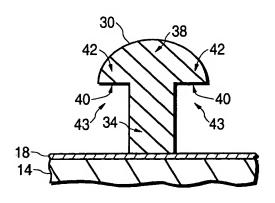
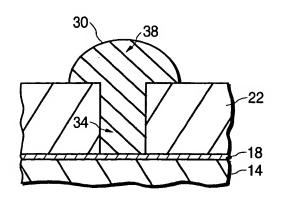
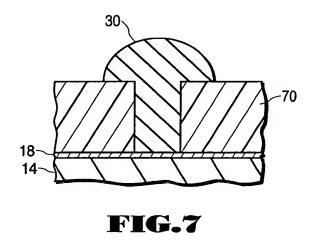
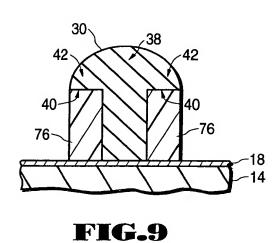
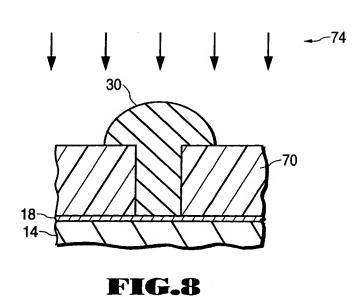


FIG.3 (PRIOR ART) FIG.6 (PRIOR ART)









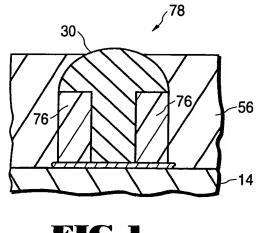
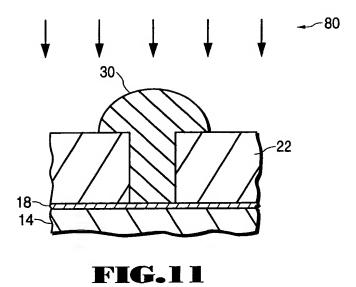


FIG.1

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30 42 76 43 43 18 14

FIG.13

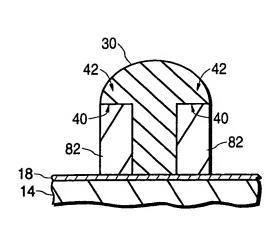


FIG.12

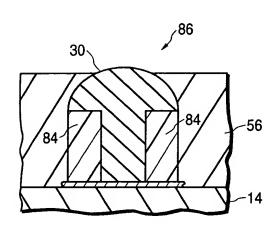


FIG.14

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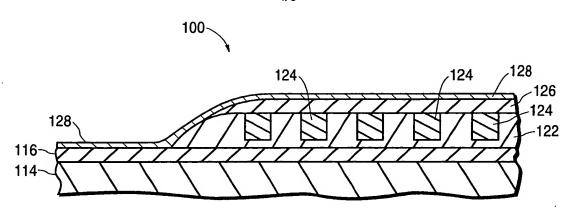


FIG.15 (PRIOR ART)

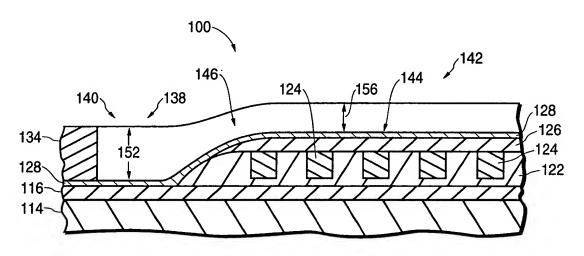


FIG.16 (PRIOR ART)

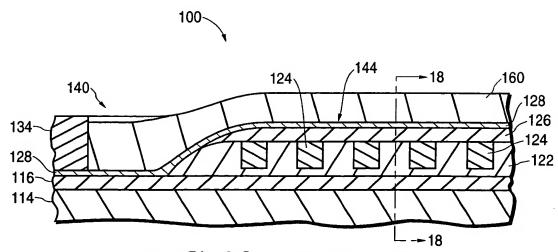


FIG.17 (PRIOR ART)

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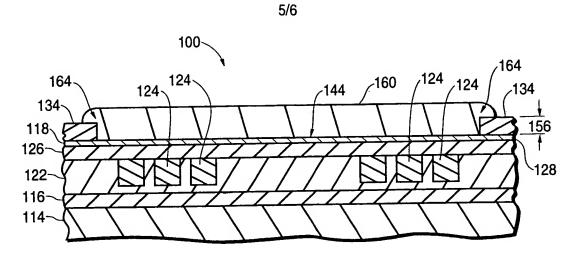


FIG.18 (PRIOR ART)

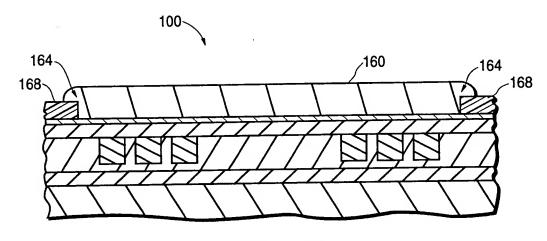


FIG.19

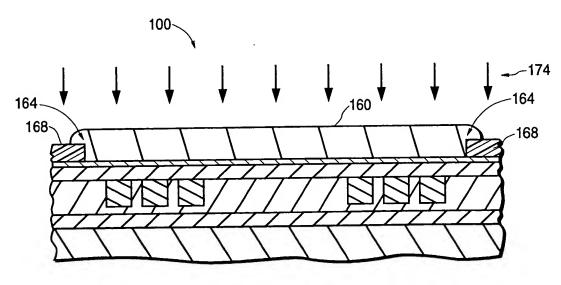


FIG.20

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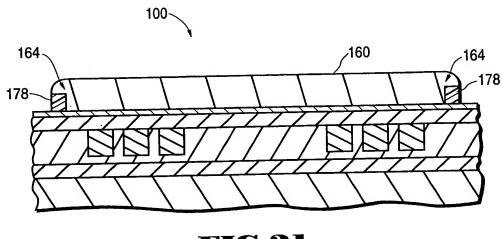


FIG.21

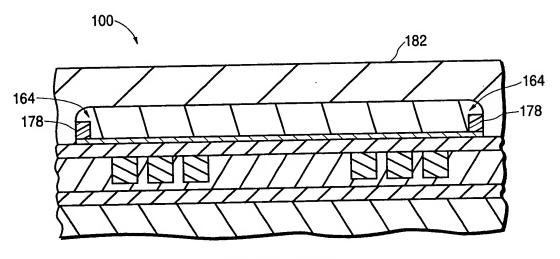


FIG.22

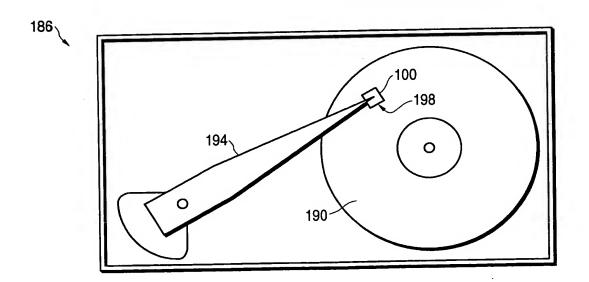


FIG.23